Waveguide type dielectric resonators – Part 1-5: General information and test conditions – Measurement method of conductivity at interface between conductor layer and dielectric substrate at microwave frequency
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INTERNATIONAL ELECTROTECHNICAL COMMISSION

WAVEGUIDE TYPE DIELECTRIC RESONATORS –

Part 1-5: General information and test conditions – Measurement method of conductivity at interface between conductor layer and dielectric substrate at microwave frequency

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IEC/PAS 61338-1-5 has been processed by IEC technical committee 49: Piezoelectric and dielectric devices for frequency control and selection.

The text of this PAS is based on the following document:

Draft PAS

This PAS was approved for publication by the P-members of the committee concerned as indicated in the following document

Report on voting

49/873/PAS

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Following publication of this PAS, which is a pre-standard publication, the technical committee or subcommittee concerned may transform it into an International Standard.

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at the end of which it shall be published as another type of normative document, or shall be withdrawn.

A list of all parts of IEC 61338 series under the general title *Waveguide type dielectric resonators* can be found on the IEC website.

IEC 61338 consists of the following parts, under the general title *Waveguide type dielectric resonators*:

Part 1: Generic specification
Part 1-3: General information and test conditions - Measurement method of complex relative permittivity for dielectric resonator materials at microwave frequency
Part 1-4: General information and test conditions - Measurement method of complex relative permittivity for dielectric resonator materials at millimeter-wave frequency
Part 2: Guidelines for oscillator and filter applications
Part 4: Sectional specification
Part 4-1: Blank detail specification
INTRODUCTION

The International Electrotechnical Commission (IEC) draws attention to the fact that it is claimed that compliance with this PAS may involve the use of a patent concerning:

“Measurement method of conductivity at interface of conductor layer”
“Measurement method of conductivity of conductor layer”

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WAVEGUIDE TYPE DIELECTRIC RESONATORS –

Part 1-5: General information and test conditions – Measurement method of conductivity at interface between conductor layer and dielectric substrate at microwave frequency

1 Scope

Microwave circuits are popularly formed on multi-layered organic or non-organic substrates. In the microwave circuits, the attenuation of planar transmission lines such as striplines, microstrip lines, and coplanar lines are determined by their conductor loss, dielectric loss and radiation loss. Among them, the conductor loss is a major factor in the attenuation of the planar transmission lines. A new measurement method is needed to evaluate the conductivity of transmission line on or in the substrates such as the organic, ceramic and LTCC (low temperature co-fired ceramics) substrates.

The IEC 61338-1-3 described the measurement method for the surface resistance $sR$ and effective conductivity $\sigma$ on the surface of the conductor. The term $\sigma$ is designated as $s\sigma$ in this PAS, and is called surface conductivity (Figure 1). This PAS describes a measurement method for resistance and effective conductivity at the interface between conductor layer and dielectric substrate designated as $iR$ and $i\sigma$, respectively, and are called interface resistance and interface conductivity.

For the transmission line in the substrates, the electric current is concentrated at the interface between conductor layer and dielectric substrate, because the skin depth $\delta$ in the conductor is the order of $\mu m$ in thickness at the microwave frequencies. In microstrip lines, the current is concentrated at the interface, rather than at the open face of the conductor. Furthermore, in copper-clad organic substrates, the interface side of the copper foil has rugged structure to hold the strong adhesive strength. In LTCC substrates, the interface between the conductor and ceramics has a rough structure, depending on the co-firing process and the material compositions. The interface conditions increase the conductor loss. Therefore, the evaluation of $iR$ and $i\sigma$ is important to design microwave circuit and to improve the conductor fabrication process.

This measurement method has the following characteristics:

- the interface resistance $iR$ is obtained by measuring the resonant frequency $f_0$ and unloaded quality factor $Q_u$ of a TE$_{01\delta}$ mode dielectric rod resonator shown in Figure 2;
– the interface conductivity \( \sigma_i \) and the relative interface conductivity \( \sigma_{ri} = \sigma_i / \sigma_0 \) are calculated from the measured \( R_i \) value, where \( \sigma_0 = 5.8 \times 10^7 \) S/m is the conductivity of standard copper;
– the measurement uncertainty of \( \sigma_{ri} \) (\( \Delta \sigma_{ri} \)) is less than 5%.

2 Normative references

The following referenced documents are indispensable for the application of this PAS. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 61338-1-3: Waveguide type dielectric resonators - Part 1-3: General information and test conditions – Measurement method of complex relative permittivity for dielectric resonator materials at microwave frequency

IEC 61338-1-4: Waveguide type dielectric resonators - Part 1-4: General information and test conditions – Measurement method of complex relative permittivity for dielectric resonator materials at millimetre-wave frequency